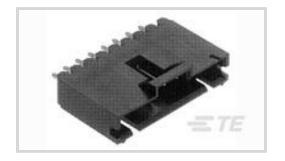


### AMPMODU | AMPMODU MTE

TE Internal #: 2-103639-8 PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU MTE

View on TE.com >

#### Connectors > PCB Connectors > PCB Headers & Receptacles



### Connector System: Wire-to-Board

Number of Positions: 8

Number of Rows: 1

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Orientation: Vertical

# Features

# **Product Type Features**

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No



PCB Connector Assembly Type PCB Mount Header   Configuration Features Vumber of Positions   Number of Positions 8
Number of Positions 8
Number of Rows 1
PCB Mount Orientation Vertical
Electrical Characteristics
Termination Resistance 15 mΩ
Insulation Resistance 5000 MΩ
Dielectric Withstanding Voltage (Max) 600 V
Body Features
Primary Product Color Black
Contact Features
Contact Mating Area Length 5.84 mm[.23 in]
Mating Square Post Dimension .64 mm[.025 in]

**C** For support call+1 800 522 6752

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU MTE



PCB Contact Termination Area Plating Material Thickness	2.54 μm[100 μin]
Contact Mating Area Plating Material Thickness	2.54 μm[100 μin]
PCB Contact Termination Area Plating Material Finish	Bright
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Bright
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.3 mm[.13 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Latched, Polarization
Mating Retention	With
Panel Mount Feature	Without
Mating Retention Type	Polarized Lock
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Connector Length	22.86 mm[.9 in]
Connector Height	13.59 mm[.535 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Jsage Conditions	

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU MTE



Circuit Application	Signal
Industry Standards	
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	92
Packaging Type	Box, Tube
Product Compliance	
-	Compliant
For compliance documentation, visit the product page on TE.com>	Compliant Compliant

### Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Reflow solder capable to 260°C

### Solder Process Capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU MTE





# Also in the Series | AMPMODU MTE



Standard Rectangular Connectors(2)

Wire-to-Board Connector Assemblies & Housings(585)

Wire-to-Board Connector Contacts(32)

# Customers Also Bought



PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU MTE





# Documents

# Product Drawings 08 MTE HDR SRST LATCH .100CL

English

### **CAD** Files

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2-103639-8\_AA.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_2-103639-8\_AA.3d\_igs.zip

English

Customer View Model

## ENG\_CVM\_CVM\_2-103639-8\_AA.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English